

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KELVIN PO LEUNG PUN	10/03/2016
CHEE WAH CHEUNG	10/03/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	COMPASS TECHNOLOGY COMPANY LIMITED
<b>Street Address:</b>	SUITE 10, 5/F, CHIAHPUA CENTRE
<b>Internal Address:</b>	12 SIU LEK YUEN ROAD
<b>City:</b>	SHATIN
<b>State/Country:</b>	HONG KONG
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15286849
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	CT16-002
<b>NAME OF SUBMITTER:</b>	STEPHEN ACKERMAN
<b>SIGNATURE:</b>	/Stephen Ackerman/
<b>DATE SIGNED:</b>	01/02/2017
<b>Total Attachments: 2</b>	
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source=CT16-002_Assignment#page2.tif	

For U.S. and/or Foreign Rights  
 For  Application or U.S. Patent  
 By  Inventor(s) or  Present Owner

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

**ASSIGNOR:**

Kelvin Po Leung Pun  
 Type or print name of ASSIGNOR  
Flat E, Tower 18, Phase 2, Double Over Starview  
 Street Address  
Hong Kong, Hong Kong  
 City, State, Country, Zip  
Hong Kong  
 Nationality

Chee Wah Cheung  
 Type or print name of ASSIGNOR  
Flat 3C, 34 Fa Post Street  
 Street Address  
Kowloon, Hong Kong  
 City, State, Country, Zip  
USA  
 Nationality

hereby sells, assigns and transfers to

**ASSIGNEE:**

**Compass Technology Company Limited**  
**Suite 10, 5/F, Chiaphua Centre, 12 Siu Lek**  
**Yuen Rd.,**  
**Shatin, New Territories, Hong Kong**  
 Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

the entire right, title and interest  
 an undivided \_\_\_\_\_ percent (\_\_\_%) interest for the United States and its territorial possessions

(check the following box/f foreign rights are also to be assigned)

and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

**Fabrication Process and Structure of Fine Pitch Traces for a Solid State Diffusion Bond on Flip Chip Interconnect**

and which is found in

- (a) U.S. patent application executed on even date herewith
- (b) U.S. patent application executed on \_\_\_\_\_
- (c) U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_
- (d) U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
*(also check (e) if foreign application(s) is also being assigned)*
- (e) and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed

**WARNING** Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Chensu Chen  
Signature of ASSIGNOR

3<sup>rd</sup> Oct, 2016  
Date of Signing

[Signature]  
Signature of ASSIGNOR

3<sup>rd</sup> Oct, 2016  
Date of Signing

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

\_\_\_Notarization of Legalization Page Added.